

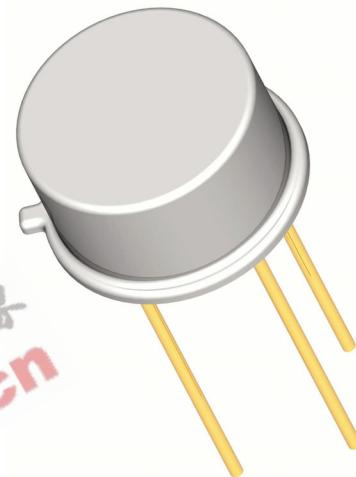
Description

Semicoa Semiconductors offers:

- Screening and processing per MIL-PRF-19500 Appendix E
- JAN level (2N3506ALJ)
- JANTX level (2N3506ALJX)
- JANTXV level (2N3506ALJV)
- JANS level (2N3506ALJS)
- QCI to the applicable level
- 100% die visual inspection per MIL-STD-750 method 2072 for JANTXV and JANS
- Radiation testing (total dose) upon request

Applications

- General purpose switching transistor
- Low power
- NPN silicon transistor



Features

- Hermetically sealed TO-5 metal can
- Also available in chip configuration
- Chip geometry 1506
- Reference document: MIL-PRF-19500/349

Benefits

- Qualification Levels: JAN, JANTX, JANTXV and JANS
- Radiation testing available

Please contact Semicoa for special configurations
www.SEMICOA.com or (714) 979-1900

Absolute Maximum Ratings		$T_c = 25^\circ\text{C}$ unless otherwise specified	
Parameter	Symbol	Rating	Unit
Collector-Emitter Voltage	V_{CEO}	40	Volts
Collector-Base Voltage	V_{CBO}	60	Volts
Emitter-Base Voltage	V_{EBO}	5	Volts
Collector Current, Continuous	I_C	3	A
Power Dissipation, $T_A = 25^\circ\text{C}$ Derate linearly above 25°C	P_T	1 5.71	W mW/ $^\circ\text{C}$
Power Dissipation, $T_c = 25^\circ\text{C}$ Derate linearly above 25°C	P_T	5 28.6	W mW/ $^\circ\text{C}$
Thermal Resistance	$R_{\theta JA}$	175	$^\circ\text{C}/\text{W}$
Operating Junction Temperature	T_J	-65 to +200	$^\circ\text{C}$
Storage Temperature	T_{STG}	-65 to +200	$^\circ\text{C}$

ELECTRICAL CHARACTERISTICS

 characteristics specified at $T_A = 25^\circ\text{C}$

Off Characteristics						
Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Collector-Base Breakdown Voltage	$V_{(\text{BR})\text{CBO}}$	$I_C = 100 \mu\text{A}$	60			Volts
Collector-Emitter Breakdown Voltage	$V_{(\text{BR})\text{CEO}}$	$I_C = 10 \text{ mA}$	40			Volts
Emitter-Base Breakdown Voltage	$V_{(\text{BR})\text{EBO}}$	$I_E = 10 \mu\text{A}$	5			Volts
Collector-Emitter Cutoff Current	$I_{\text{CEX}1}$	$V_{\text{CE}} = 40 \text{ Volts}, V_{\text{EB}} = 4 \text{ Volts}$			1	μA
Collector-Emitter Cutoff Current	$I_{\text{CEX}2}$	$V_{\text{CE}} = 40 \text{ Volts}, V_{\text{EB}} = 4 \text{ Volts}, T_A = 150^\circ\text{C}$			1.5	mA

On Characteristics						
Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
DC Current Gain	$h_{\text{FE}1}$ $h_{\text{FE}2}$ $h_{\text{FE}3}$ $h_{\text{FE}4}$ $h_{\text{FE}5}$	$I_C = 500 \text{ mA}, V_{\text{CE}} = 1 \text{ Volts}$ $I_C = 1.5 \text{ A}, V_{\text{CE}} = 2 \text{ Volts}$ $I_C = 2.5 \text{ A}, V_{\text{CE}} = 3 \text{ Volts}$ $I_C = 3.0 \text{ A}, V_{\text{CE}} = 5 \text{ Volts}$ $I_C = 500 \text{ mA}, V_{\text{CE}} = 2 \text{ Volts}$ $T_A = -55^\circ\text{C}$	50 40 30 25 25		250 200	
Base-Emitter Saturation Voltage	$V_{\text{BEsat}1}$ $V_{\text{BEsat}2}$ $V_{\text{BEsat}3}$	$I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$ $I_C = 1.5 \text{ A}, I_B = 150 \text{ mA}$ $I_C = 2.5 \text{ A}, I_B = 250 \text{ mA}$			0.5 1.0 1.5	Volts
Collector-Emitter Saturation Voltage	$V_{\text{CESat}1}$ $V_{\text{CESat}2}$ $V_{\text{CESat}3}$	$I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$ $I_C = 1.5 \text{ A}, I_B = 150 \text{ mA}$ $I_C = 2.5 \text{ A}, I_B = 250 \text{ mA}$	0.8		1.0 1.3 2.0	Volts

Dynamic Characteristics						
Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Magnitude – Common Emitter, Short Circuit Forward Current Transfer Ratio	$ h_{\text{FE}} $	$V_{\text{CE}} = 5 \text{ Volts}, I_C = 100 \text{ mA}, f = 20 \text{ MHz}$	3		15	
Open Circuit Output Capacitance	C_{OBO}	$V_{\text{CB}} = 10 \text{ Volts}, I_E = 0 \text{ mA}, 100 \text{ kHz} < f < 1 \text{ MHz}$			40	pF
Open Circuit Input Capacitance	C_{IBO}	$V_{\text{EB}} = 3 \text{ Volts}, I_C = 0 \text{ mA}, 100 \text{ kHz} < f < 1 \text{ MHz}$			300	pF
Delay Time	t_d	$I_C = 1.5 \text{ A}, I_{B1} = 150 \text{ mA}$			15	ns
Rise Time	t_r	$I_C = 1.5 \text{ A}, I_{B1} = 150 \text{ mA}$			30	ns

Switching Characteristics						
Storage Time	t_s	$I_C = 1.5 \text{ A}, I_{B1}=I_{B2} = 150 \text{ mA}$			55	ns
Fall Time	t_f	$I_C = 1.5 \text{ A}, I_{B1}=I_{B2} = 150 \text{ mA}$			35	ns